

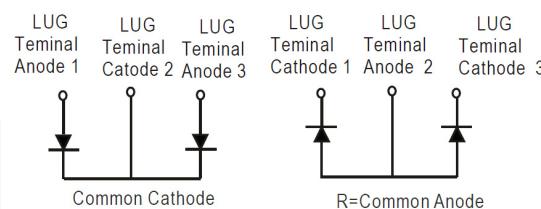
Low V_F Silicon Power Schottky Diode

V_{RRM} = 20 V
I_{F(AV)} = 300 A

Features

- High Surge Capability
- Type 20 V V_{RRM}
- Isolation Type Package
- Electrically Isolated Base Plate
- Not ESD Sensitive

Three Tower Package



Maximum ratings, at T_j = 25 °C, unless otherwise specified ("R" devices have leads reversed)

Parameter	Symbol	Conditions	MBRT30020(R)L	Unit
Maximum recurrent peak reverse voltage	V _{RRM}		20	V
Maximum RMS voltage	V _{RMS}		14	V
Maximum DC blocking voltage	V _{DC}		20	V
Operating temperature	T _j		-55 to 150	°C
Storage temperature	T _{stg}		-55 to 150	°C

Electrical characteristics, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	MBRT30020(R)L	Unit
Average forward current (per pkg)	I _{F(AV)}	T _C = 100 °C	300	A
Peak forward surge current (per leg)	I _{FSM}	t _p = 8.3 ms, half sine	2000	A
Maximum instantaneous forward voltage (per leg)	V _F	I _{FM} = 150 A, T _j = 25 °C	0.58	V
Maximum instantaneous reverse current at rated DC blocking voltage (per leg)	I _R	T _j = 25 °C T _j = 100 °C	3 100	mA

Thermal characteristics

Maximum thermal resistance, junction - case (per leg)	R _{θJC}	0.40	°C/W
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Figure .1-Typical Forward Characteristics

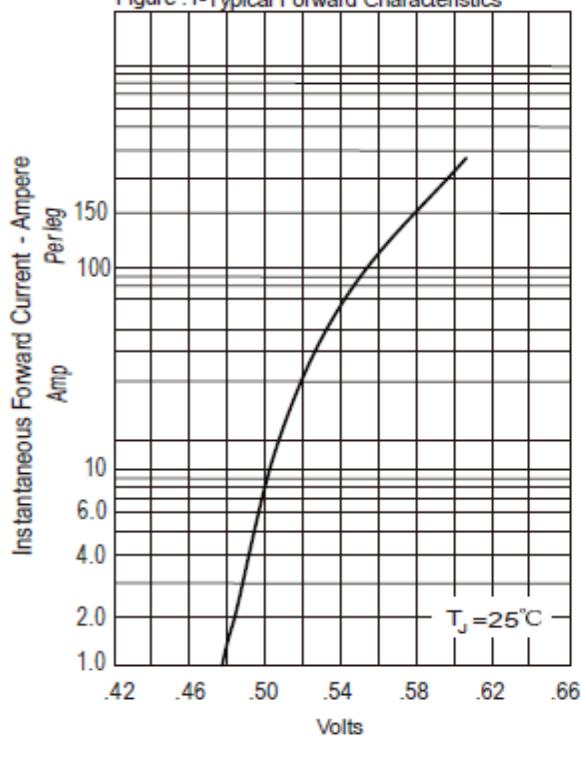


Figure .2-Forward Derating Curve

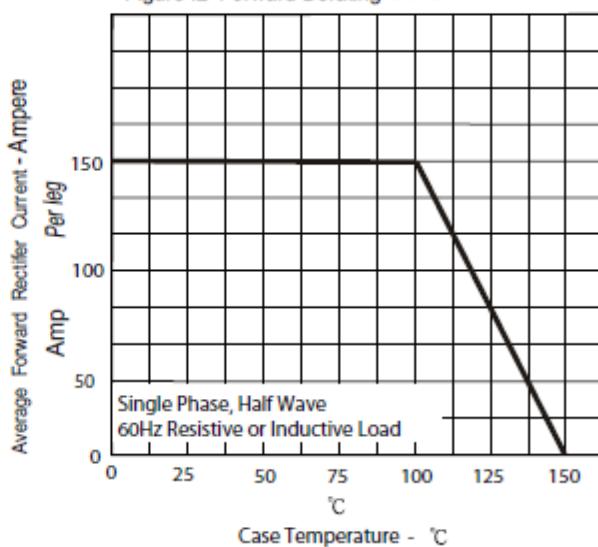


Figure .3-Peak Forward Surge Current

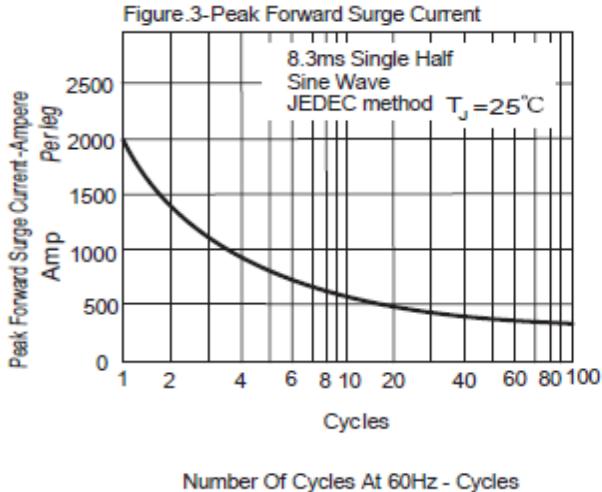
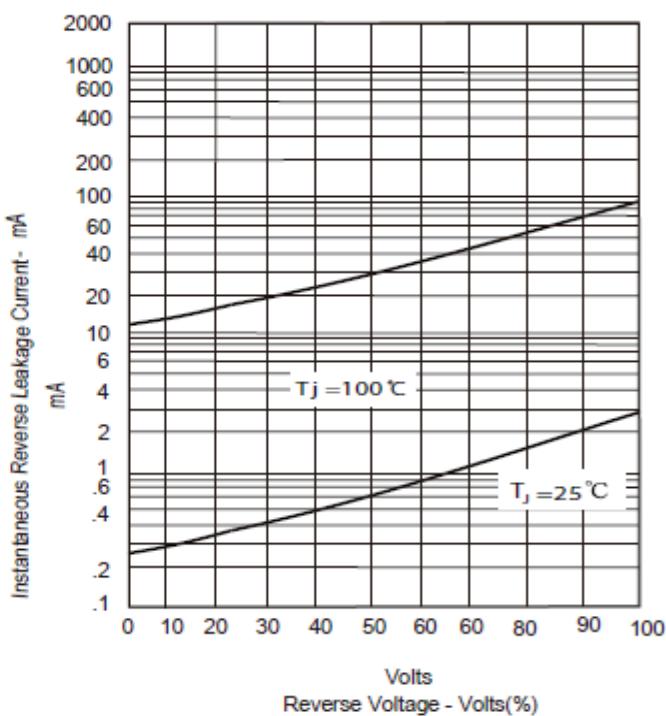
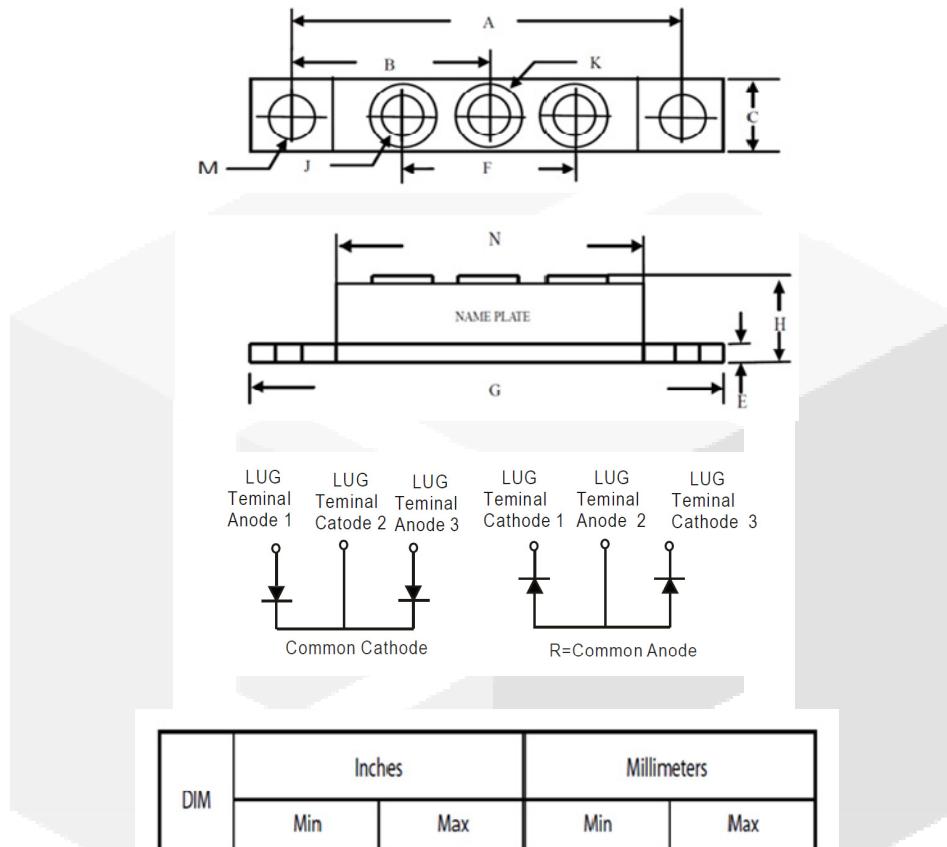


Figure .4-Typical Reverse Characteristics



Package dimensions and terminal configuration

Product is marked with part number and terminal configuration.



DIM	Inches		Millimeters	
	Min	Max	Min	Max
A	3.150	NOM	80.01	NOM
B	1.565	1.585	39.75	40.26
C	.700	.800	17.78	20.32
E	.119	.132	3.02	3.35
F	1.327	REF	33.72	REF
G	3.55	3.65	90.17	92.71
H	----	.73	----	18.30
J	1/4-20 UNC FULL			
K	.472	.511	12	13
M	.275	.295	6.99	7.49
N	2.38	2.46	60.5	62.5